



UW-Madison and Hon Hai Precision Industry Co., Ltd.

Collaboration Declaration

Vision

Hon Hai Precision Industry Co., Ltd. ("Foxconn"), a global technology leader, and the University of Wisconsin-Madison, a world-class public research university, agree to pursue a multi-faceted, multi-disciplined collaboration as provided herein to enable the development of talent & technology and engender investment & economic growth across Wisconsin.

Every successful cluster of economic growth and innovation in the U.S. has at least one world-class research university centrally located in it. Most notably, the synergies between the emerging technologies and the universities in the Palo Alto/San Francisco region helped create Silicon Valley, just as the synergies between biotech companies and the Bostonarea universities helped created the Boston technology corridor.

The commitment of Foxconn to build the Wisconn Valley Science & Technology Park – anchored by the first and only TFT-LCD fabrication plant in North America - coupled with the trailblazing interdisciplinary research in fundamental and applied science conducted by the renowned researchers, faculty, staff and students of UW-Madison will serve as the catalyst for extraordinary innovation and discovery and will stimulate similar economic growth. Foxconn, the global leader in manufacturing services for the computer, communication, and consumer electronics (3C) industry and ranked number 27 on the Fortune magazine Global 500 list in 2017, has grown to its enormous scale by embracing innovation, research, and development. UW-Madison is one of the nation's leading producers of PhDs and Fortune 500 CEOs and currently ranks 6th in the nation for volume of research. UW-Madison also has over 15 consecutive years of more than 100 patent disclosures. The world-class capabilities of UW-Madison in disciplines ranging from computer science and engineering, to health care technology, manufacturing and mobility, to biotechnology and beyond seamlessly complement Foxconn's ability to assess, develop, and commercialize disruptive innovation. The dynamic synergy realized by combining research and innovation will foster breakthroughs in applications as far-reaching as Advanced Technology on Panel (ATOP), Biochips, Semiconductor Physics, ASIC, Smart Building, Smart Infrastructure and Smart City Development, High Performance Computing, High-speed Communications Network (5G), Cloud Server Storage, Sensors, Robotics, Display, IT Systems, Genomics, Immune Cell Research, Clinical Data Integrity, and Medical Imaging.

Collaboration Principles

In guiding the implementation and growth of this collaboration, the parties commit to the following principles:

- 1. Shared Investment, Shared Benefit.
 - The parties anticipate that a variety of research agreements may be necessary, given the wide range of potential collaborations present between our two organizations. A separate master cooperation agreement will provide a framework for intellectual property, publication and other parameters. Both Foxconn and UW-Madison must be able to benefit from new discoveries and any intellectual property that results.
- 2. A Shared Commitment to Advancing Student Education and Excellence.

 For all collaboration directly involving students, Foxconn and UW-Madison commit to ensuring quality, enriching experiences for students that allow them to advance their studies and academic preparedness. For research, in





whole or part, conducted by students, the parties commit to ensuring their ability to advance in their studies and to publish findings in academic and scholarly journals.

- 3. A Presence in Madison and Wisconn Valley Science and Technology Park.
 Because the collaboration between the parties will only be strengthened by the frequency of our interactions and colocation of Foxconn and UW-Madison community members, the parties commit to pursuing new ways to ensure deep, meaningful presence at each other's key locations.
- 4. Retaining UW Graduates through Strong Talent Pipelines.
 The parties have a shared interest in building a strong, vibrant workforce for the state of Wisconsin, both in careers at Foxconn and through their in-state supplier networks. The parties commit to joining the career counseling and advising resources of UW-Madison with the recruiting teams from Foxconn to ensure high student awareness of relevant career opportunities.

Intentions

Foxconn intends to make a \$100 million investment in research and other activities with UW-Madison, whereas UW-Madison intends to secure an equivalent amount of funding to support complementary programs in engineering (including the new facility referenced in 2.c.), computing and data sciences, and advancements in human health (including those referenced in 1.) as part of a newly launched targeted campaign for those areas within the All Ways Forward campaign. Foxconn and UW-Madison will also make best efforts to jointly secure funds from outside partners, all for the purposes specified in the following:

- 1. A collaboration among Foxconn, UW-Madison, the UW Carbone Cancer Center, and UW Health to pursue advancements in areas such as genomics/multi-omics; novel radio- and cellular-therapies; and molecular diagnostics, ginseng, clinical data integrity, and medical imaging in cancer and related disease.
- The creation of the Foxconn Institute for Research in Science and Technology ("FIRST") to pursue advancements in semiconductor, TFT, sensor and LCD panel technologies; advanced manufacturing, robotics and industrial internet; autonomous vehicles and mobility; and, Al-enabled smart construction and smart cities technologies.
 - a. FIRST will be located primarily in a newly constructed facility in the Wisconn Valley Science & Technology Park in Mt. Pleasant, Racine County, Wisconsin.
 - b. FIRST will also have a significant physical presence near the UW-Madison campus to facilitate collaboration and to support research conducted at the university in areas of interest to FIRST.
 - c. Foxconn also intends to provide significant funding toward a new facility on the UW-Madison campus, that will be located in close proximity to the College of Engineering, Department of Computer Science, and School of Business in which research of interest to FIRST will be conducted.
 - d. FIRST will cover multi-/inter-/cross-disciplinary research and development endeavors that touch upon Civil & Environmental Engineering, Chemical & Biological Engineering, Mechanical Engineering, Electrical & Computer Engineering, Biomedical Engineering, Computer Science, Data Science, Material Science, and Industrial and Systems Engineering.
- 3. Foxconn agrees to provide, upon consultation with UW-Madison, the following:
 - a. The physical infrastructure for FIRST and future facilities as stipulated in respective development agreements.
 - b. Access to Foxconn high performance computing, high-speed networking, cloud server storage capabilities as well as sensor, robotics, display and IT systems technologies, where applicable.
 - c. Access to Foxconn large-scale fabrication and micro-fabrication, where applicable.





Foxconn and UW-Madison further agree to continue to seek out and develop novel initiatives that will promote technological advancement, excellence in education, pioneer research and development and foster an environment of multi-institutional collaboration, innovation and entrepreneurism.

Signed this 27th day of August 2018.

UNIVERSITY OF WISCONSIN-MADISON

Rebecca M. Blank

Chancellor

HON HAI PRECISION INDUSTRY CO., LTD.

Ferry Gou

Founder, Chairman & CEO